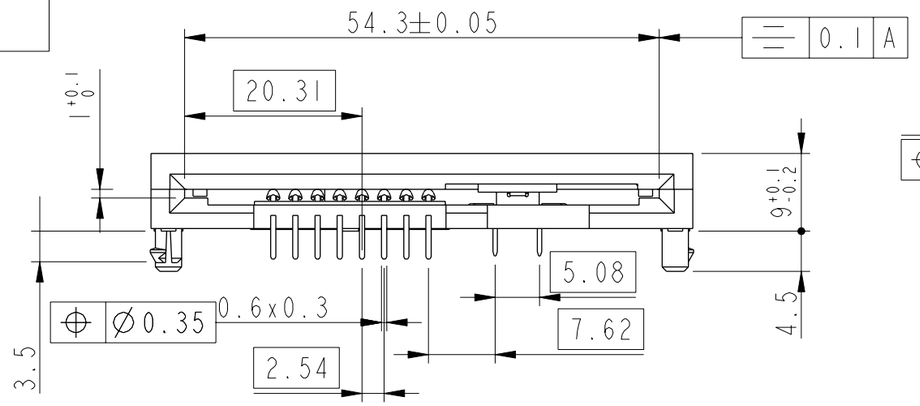
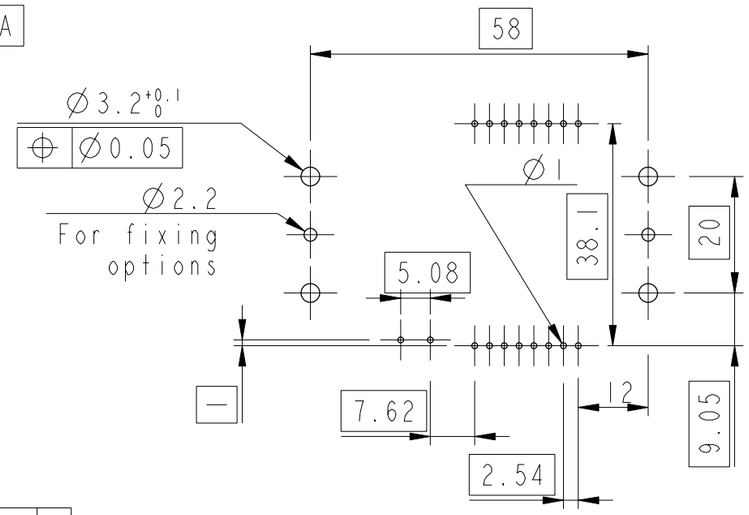
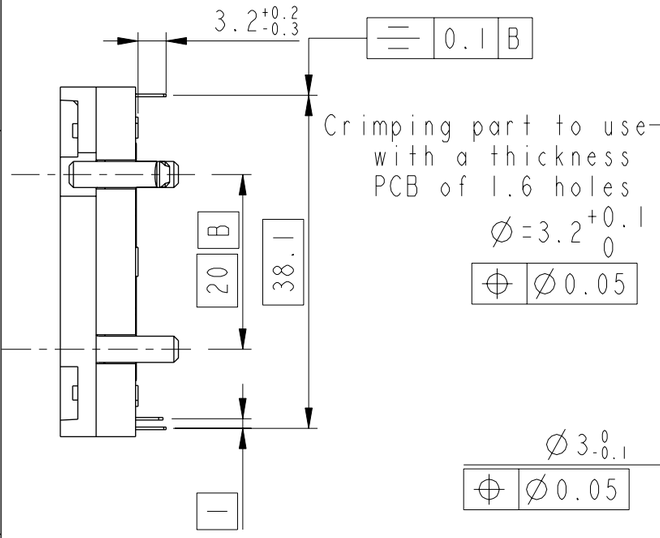
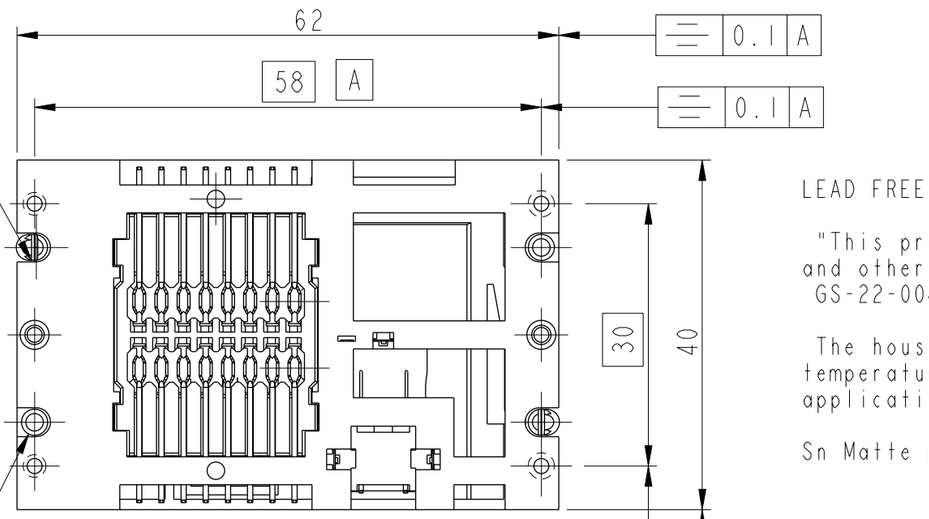
CATALOGUE NUMBER	LEAD FREE VERSION
7434L0835S01	7434L0835S01LF



IMPLANTATION C.1
PCB FOOTPRINT







LEAD FREE VERSION:

"This product meets European Union Directives and other country regulations as described in GS-22-008"

The housing will withstand exposure to 260°C peak temperature for 3-5seconds in a wave solder application with a 1.6mm minimum thick circuit board.

Sn Matte plating on solder tail for Lead Free Versions

Tol Gen: 0mm to 10mm ±0.1mm
10mm to 30mm ±0.15mm
30mm to 60mm ±0.2mm
60mm and above ±0.3mm

rev	ecn no	dr	date
A	F20307	DLE	2002/04/29
B	105-0167	NT	2005/09/26
C	106-0084	SSC	2006/06/21
D	108-0080	SSC	2008/06/28
-	-	-	-
-	-	-	-
-	-	-	-

www.fciconnect.com			surface - ISO:1302		tolerance std ISO:406 ISO:1101	projection	MM
			TOLERANCES UNLESS OTHERWISE SPECIFIED				
Dr	D.LEGRAND	2002/04/29	ANGULAR	LINEAR	0.X ±	size	Scale
Eng	F.TISSERAND	2002/04/29			0.XX ±	A3	1:1
Chr	S.S.CHERIAN	2008/06/28	0° ±°		0.XXX ±	ECN	108-0080
Appr	S.S.CHERIAN	2008/06/28	Product family		SMARTCARD	Spec ref	-
title	SMARTCARD ASSEMBLY L08-16 CONTACTS - 8 CONTACTS			dwg no	VJW12077		Rev. D
	catalog no		SEE TABLE				sheet 1 of 1

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REV F - 2006-04-17

PDM: Rev:D STATUS: Released Printed: Jan 29, 2010